



Product Change Notification

Change Notification #: 115761 - 00
Change Title: Intel® ITPMFGTEST3B,
PCN 115761-00,
Product Discontinuance, End of Life
Date of Publication: August 21, 2017

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	August 21, 2017
Last Product Discontinuance Order Date:	December 31, 2017
Last Product Discontinuance Shipment Date:	March 31, 2018

Description of Change to the Customer:

The Intel® ITPMFGTEST3B MM#914962 will end of life.

Customer Impact of Change and Recommended Action:

Customers should place their Last Time Orders by December 31, 2017 and delivery of all orders must be taken no later than March 31, 2018.

Milestone dates are estimates and subject to change based on business and operations conditions.

Please contact your local Intel Field Sales Representative if you have and further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Product Code	MM#
ITPMFGTEST3B	941962

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 21, 2017	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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